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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c44t-33e-pq

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9.2 PORTB and DDRB Registers

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is DDRB. A '1' in DDRB configures the corresponding port pin as an input. A '0' in the DDRB register configures the corresponding port pin as an output. Reading PORTB reads the status of the pins, whereas writing to it will write to the port latch.

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is done by clearing the $\overline{\text{RBPU}}$ (PORTA<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are enabled on any reset.

PORTB also has an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e. any RB7:RB0 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB0) are compared with the value in the PORTB data latch. The "mismatch" outputs of RB7:RB0 are OR'ed together to generate the PORTB Interrupt Flag RBIF (PIR<7>). This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt by:

- a) Read-Write PORTB (such as; MOVPF PORTB, PORTB). This will end mismatch condition.
- b) Then, clear the RBIF bit.

A mismatch condition will continue to set the RBIF bit. Reading then writing PORTB will end the mismatch condition, and allow the RBIF bit to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on this port, allows easy interface to a key pad and make it possible for wake-up on key-depression. For an example, refer to AN552 in the *Embedded Control Handbook*.

The interrupt on change feature is recommended for wake-up on operations where PORTB is only used for the interrupt on change feature and key depression operation.



FIGURE 9-4: BLOCK DIAGRAM OF RB<7:4> AND RB<1:0> PORT PINS

11.0 TIMER0

The Timer0 module consists of a 16-bit timer/counter, TMR0. The high byte is TMR0H and the low byte is TMR0L. A software programmable 8-bit prescaler makes an effective 24-bit overflow timer. The clock source is also software programmable as either the internal instruction clock or the RA1/T0CKI pin. The control bits for this module are in register T0STA (Figure 11-1).

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0	
INTEDG bit7	TOSE	TOCS	PS3	PS2	PS1	PS0	— bit0	R = Readable bit W = Writable bit U = Unimplemented, Read as '0' -n = Value at POR reset
bit 7:	INTEDG : R This bit sele 1 = Rising e 0 = Falling e	ects the ed edge of RA	ge upon w 0/INT pin g	hich the in generates i	terrupt is d nterrupt	etected		-n = value al POR lesel
bit 6:		ects the ed S = 0 edge of RA edge of RA	ge upon w 1/T0CKI pi	hich TMR(nts TMR0 a	and/or gene		CKIF interrupt CKIF interrupt
bit 5:	TOCS : Time This bit self 1 = Internal 0 = TOCKI	ects the clo instruction	ck source	for TMR0.				
bit 4-1:	PS3:PS0 : T These bits				R0.			
	PS3:PS0	Pre	scale Valu	е				
	0000 0001 0010 0011 0100 0101 0110 0111 1xxx		1:1 1:2 1:4 1:8 1:16 1:32 1:64 1:128 1:256					
bit 0:	Unimplem	ented : Rea	id as '0'					

FIGURE 11-1: T0STA REGISTER (ADDRESS: 05h, UNBANKED)

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12.0 TIMER1, TIMER2, TIMER3, PWMS AND CAPTURES

The PIC17C4X has a wealth of timers and time-based functions to ease the implementation of control applications. These time-base functions include two PWM outputs and two Capture inputs.

Timer1 and Timer2 are two 8-bit incrementing timers, each with a period register (PR1 and PR2 respectively) and separate overflow interrupt flags. Timer1 and Timer2 can operate either as timers (increment on internal Fosc/4 clock) or as counters (increment on falling edge of external clock on pin RB4/TCLK12). They are also software configurable to operate as a single 16-bit timer. These timers are also used as the time-base for the PWM (pulse width modulation) module. Timer3 is a 16-bit timer/counter consisting of the TMR3H and TMR3L registers. This timer has four other associated registers. Two registers are used as a 16-bit period register or a 16-bit Capture1 register (PR3H/CA1H:PR3L/CA1L). The other two registers are strictly the Capture2 registers (CA2H:CA2L). Timer3 is the time-base for the two 16-bit captures.

TMR3 can be software configured to increment from the internal system clock or from an external signal on the RB5/TCLK3 pin.

Figure 12-1 and Figure 12-2 are the control registers for the operation of Timer1, Timer2, and Timer3, as well as PWM1, PWM2, Capture1, and Capture2.

FIGURE 12-1: TCON1 REGISTER (ADDRESS: 16h, BANK 3)

bit7	I CA2ED0 CA1ED1 CA1ED0 T16 TMR3CS TMR2CS TMR1CS bit0	R = Readable bit W = Writable bit -n = Value at POR reset
bit 7-6:	 CA2ED1:CA2ED0: Capture2 Mode Select bits 00 = Capture on every falling edge 01 = Capture on every rising edge 10 = Capture on every 4th rising edge 11 = Capture on every 16th rising edge 	
bit 5-4:	CA1ED1:CA1ED0 : Capture1 Mode Select bits 00 = Capture on every falling edge 01 = Capture on every rising edge 10 = Capture on every 4th rising edge 11 = Capture on every 16th rising edge	
bit 3:	T16 : Timer1:Timer2 Mode Select bit 1 = Timer1 and Timer2 form a 16-bit timer 0 = Timer1 and Timer2 are two 8-bit timers	
bit 2:	TMR3CS : Timer3 Clock Source Select bit 1 = TMR3 increments off the falling edge of the RB5/TCLK3 pin 0 = TMR3 increments off the internal clock	
bit 1:	TMR2CS : Timer2 Clock Source Select bit 1 = TMR2 increments off the falling edge of the RB4/TCLK12 pin 0 = TMR2 increments off the internal clock	
bit 0:	TMR1CS : Timer1 Clock Source Select bit 1 = TMR1 increments off the falling edge of the RB4/TCLK12 pin 0 = TMR1 increments off the internal clock	

12.2.1 ONE CAPTURE AND ONE PERIOD REGISTER MODE

In this mode registers PR3H/CA1H and PR3L/CA1L constitute a 16-bit period register. A block diagram is shown in Figure 12-7. The timer increments until it equals the period register and then resets to 0000h. TMR3 Interrupt Flag bit (TMR3IF) is set at this point. This interrupt can be disabled by clearing the TMR3 Interrupt Enable bit (TMR3IE). TMR3IF must be cleared in software.

This mode is selected if control bit CA1/PR3 is clear. In this mode, the Capture1 register, consisting of high byte (PR3H/CA1H) and low byte (PR3L/CA1L), is configured as the period control register for TMR3. Capture1 is disabled in this mode, and the corresponding Interrupt bit CA1IF is never set. TMR3 increments until it equals the value in the period register and then resets to 0000h.

Capture2 is active in this mode. The CA2ED1 and CA2ED0 bits determine the event on which capture will occur. The possible events are:

- · Capture on every falling edge
- Capture on every rising edge
- · Capture every 4th rising edge
- · Capture every 16th rising edge

When a capture takes place, an interrupt flag is latched into the CA2IF bit. This interrupt can be enabled by setting the corresponding mask bit CA2IE. The Peripheral Interrupt Enable bit (PEIE) must be set and the Global Interrupt Disable bit (GLINTD) must be cleared for the interrupt to be acknowledged. The CA2IF interrupt flag bit must be cleared in software.

When the capture prescale select is changed, the prescaler is not reset and an event may be generated. Therefore, the first capture after such a change will be ambiguous. However, it sets the time-base for the next capture. The prescaler is reset upon chip reset. Capture pin RB1/CAP2 is a multiplexed pin. When used as a port pin, Capture2 is not disabled. However, the user can simply disable the Capture2 interrupt by clearing CA2IE. If RB1/CAP2 is used as an output pin, the user can activate a capture by writing to the port pin. This may be useful during development phase to emulate a capture interrupt.

The input on capture pin RB1/CAP2 is synchronized internally to internal phase clocks. This imposes certain restrictions on the input waveform (see the Electrical Specification section for timing).

The Capture2 overflow status flag bit is double buffered. The master bit is set if one captured word is already residing in the Capture2 register and another "event" has occurred on the RB1/CA2 pin. The new event will not transfer the Timer3 value to the capture register, protecting the previous unread capture value. When the user reads both the high and the low bytes (in any order) of the Capture2 register, the master overflow bit is transferred to the slave overflow bit (CA2OVF) and then the master bit is reset. The user can then read TCON2 to determine the value of CA2OVF.

The recommended sequence to read capture registers and capture overflow flag bits is shown in Example 12-1.

EXAMPLE 12-1: SEQUENCE TO READ CAPTURE REGISTERS

MOVLB 3	;Select Bank 3
MOVPF CA2L,LO_BYTE	;Read Capture2 low
	;byte, store in LO_BYTE
MOVPF CA2H, HI_BYTE	;Read Capture2 high
	;byte, store in HI_BYTE
MOVPF TCON2,STAT_VAL	;Read TCON2 into file
	;STAT_VAL

FIGURE 12-7: TIMER3 WITH ONE CAPTURE AND ONE PERIOD REGISTER BLOCK DIAGRAM



13.0 UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART) MODULE

The USART module is a serial I/O module. The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc. The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

The SPEN (RCSTA<7>) bit has to be set in order to configure RA4 and RA5 as the Serial Communication Interface.

The USART module will control the direction of the RA4/RX/DT and RA5/TX/CK pins, depending on the states of the USART configuration bits in the RCSTA and TXSTA registers. The bits that control I/O direction are:

- SPEN
- TXEN
- SREN
- CREN
- CSRC

The Transmit Status And Control Register is shown in Figure 13-1, while the Receive Status And Control Register is shown in Figure 13-2.

D 4 4 4						D (D 4 4 4			
R/W - 0 CSRC	R/W - 0 TX9	R/W - 0 TXEN	R/W - 0 SYNC	<u>U-0</u>	<u>U-0</u>	<u>R - 1</u> TRMT	R/W - x TX9D	R = Readable bit		
bit7	17.9	TALM	51110				bit0	W = Writable bit-n = Value at POR reset(x = unknown)		
bit 7: CSRC: Clock Source Select bit <u>Synchronous mode:</u> 1 = Master Mode (Clock generated internally from BRG) 0 = Slave mode (Clock from external source) <u>Asynchronous mode</u> : Don't care										
bit 6:	TX9 : 9-bit Transmit Enable bit 1 = Selects 9-bit transmission 0 = Selects 8-bit transmission									
bit 5:	TXEN : Tra 1 = Transr 0 = Transr SREN/CR	nit enable nit disable	d ed	in SYNC	mode					
bit 4:	SYNC: US (Synchror 1 = Synch 0 = Async	nous/Asyn Ironous m	chronous) ode							
bit 3-2:	Unimpler	nented: R	ead as '0'							
bit 1:	TRMT : Transmit Shift Register (TSR) Empty bit 1 = TSR empty 0 = TSR full									
bit 0:	TX9D : 9th	bit of trar	emit data	(can be u	and to only	مطلا امملمان	nority in on	ft		

FIGURE 13-1: TXSTA REGISTER (ADDRESS: 15h, BANK 0)

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TABLE 13-7: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
16h, Bank 0	TXREG	TX7	TX6	TX5	TX4	TX3	TX2	TX1	TX0	xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—		TRMT	TX9D	00001x	00001u
17h, Bank 0	17h, Bank 0 SPBRG Baud rate generator register								•	xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for synchronous master transmission.

Note 1: Other (non power-up) resets include: external reset through MCLR and Watchdog Timer Reset.

FIGURE 13-9: SYNCHRONOUS TRANSMISSION



FIGURE 13-10: SYNCHRONOUS TRANSMISSION (THROUGH TXEN)



13.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once synchronous mode is selected, reception is enabled by setting either the SREN (RCSTA<5>) bit or the CREN (RCSTA<4>) bit. Data is sampled on the RA4/RX/DT pin on the falling edge of the clock. If SREN is set, then only a single word is received. If CREN is set, the reception is continuous until CREN is reset. If both bits are set, then CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to RCREG (if it is empty). If the transfer is complete, the interrupt bit RCIF (PIR<0>) is set. The actual interrupt can be enabled/disabled by setting/clearing the RCIE (PIE<0>) bit. RCIF is a read only bit which is RESET by the hardware. In this case it is reset when RCREG has been read and is empty. RCREG is a double buffered register; i.e., it is a two deep FIFO. It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR. On the clocking of the last bit of the third byte, if RCREG is still full, then the overrun error bit OERR (RCSTA<1>) is set. The word in the RSR will be lost. RCREG can be read twice to retrieve the two bytes in the FIFO. The OERR bit has to be cleared in software. This is done by clearing the CREN bit. If OERR bit is set, transfers from RSR to RCREG are inhibited, so it is essential to clear OERR bit if it is set. The 9th receive bit is buffered the same way as the receive data. Reading the RCREG register will allow the RX9D and FERR bits to be loaded with values for the next received data: therefore, it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

Steps to follow when setting up a Synchronous Master Reception:

- 1. Initialize the SPBRG register for the appropriate baud rate. See Section 13.1 for details.
- 2. Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- 3. If interrupts are desired, then set the RCIE bit.
- 4. If 9-bit reception is desired, then set the RX9 bit.
- 5. If a single reception is required, set bit SREN. For continuous reception set bit CREN.
- 6. The RCIF bit will be set when reception is complete and an interrupt will be generated if the RCIE bit was set.
- 7. Read RCSTA to get the ninth bit (if enabled) and determine if any error occurred during reception.
- 8. Read the 8-bit received data by reading RCREG.
- 9. If any error occurred, clear the error by clearing CREN.

Note: To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.



FIGURE 13-11: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

SWAPF	Swap f								
Syntax:	[label]	SWAPF	f,d						
Operands:	$\begin{array}{l} 0 \leq f \leq 255 \\ d \in \ [0,1] \end{array}$	0 ≤ f ≤ 255 d ∈ [0,1]							
Operation:	$f < 3:0 > \rightarrow f < 7:4 > \rightarrow$,						
Status Affected:	None								
Encoding:	0001	110d	ffff	ffff					
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed in register 'f'.								
Words:	1								
Cycles:	1	1							
Q Cycle Activity:									
Q1	Q2	Q	3	Q4					
Decode	Read register 'f'	Exect		Vrite to stination					
Example:	SWAPF I	REG,	0						
Before Instru REG	uction = 0x53								
After Instruc REG	tion = 0x35								

TABLRD	Table Rea	d						
Syntax:	[label]	[label] TABLRD t,i,f						
Operands:	$0 \le f \le 255$ $i \in [0,1]$ $t \in [0,1]$							
Operation:	$\label{eq:states} \begin{array}{l} \text{If } t = 1, \\ & \text{TBLATH} \rightarrow \text{f}; \\ \text{If } t = 0, \\ & \text{TBLATL} \rightarrow \text{f}; \\ & \text{Prog Mem (TBLPTR)} \rightarrow \text{TBLAT}; \\ \text{If } i = 1, \\ & \text{TBLPTR} + 1 \rightarrow \text{TBLPTR} \end{array}$							
Status Affected:	None							
Encoding:	1010	10ti ff	ff ffff					
Description:	is mov If t = 0	of the table I ed to register the high byte the low byte	file 'f'. e is moved;					
	 Then the contents of the program memory location pointed to by the 16-bit Table Pointer (TBLPTR) is loaded into the 16-bit Table Latch (TBLAT). If i = 1: TBLPTR is incremented; If i = 0: TBLPTR is not 							
Words:	1	incremented						
Cycles:	2 (3 cycle	if f = PCL)						
Q Cycle Activity:								
Q1	Q2	Q3	Q4					
Decode	Read register TBLATH or TBLATL	Execute	Write register 'f'					

Applicable Devices 42 R42 42A 43 R43 44

18.0 PIC17C42 DC AND AC CHARACTERISTICS

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed. In some graphs or tables the data presented are outside specified operating range (e.g. outside specified VDD range). This is for information only and devices are ensured to operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3σ) and (mean - 3σ) respectively where σ is standard deviation.

TABLE 18-1: PIN CAPACITANCE PER PACKAGE TYPE

Pin Name	Typical Capacitance (pF)							
	40-pin DIP	44-pin PLCC	44-pin MQFP	44-pin TQFP				
All pins, except MCLR, VDD, and VSS	10	10	10	10				
MCLR pin	20	20	20	20				

FIGURE 18-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE



Applicable Devices 42 R42 42A 43 R43 44





FIGURE 18-12: MAXIMUM IPD vs. VDD WATCHDOG ENABLED

Applicable Devices 42 R42 42A 43 R43 44

19.3 DC CHARACTERISTICS:

PIC17CR42/42A/43/R43/44-16 (Commercial, Industrial) PIC17CR42/42A/43/R43/44-25 (Commercial, Industrial) PIC17CR42/42A/43/R43/44-33 (Commercial, Industrial) PIC17LCR42/42A/43/R43/44-08 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated) Operating temperature

DC CHARACTERISTICS

-40°C \leq TA \leq +85°C for industrial and 0°C \leq TA \leq +70°C for commercial

	$0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial Operating voltage VDD range as described in Section 19.1						
Demonst		1	Operating v	oitage VI	טט range a	is desc	cribed in Section 19.1
Parameter No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
		Input Low Voltage					
	VIL	I/O ports					
D030		with TTL buffer	Vss	-	0.8	V	$4.5V \le VDD \le 5.5V$
			Vss	-	0.2Vdd	V	$2.5V \le VDD \le 4.5V$
D031		with Schmitt Trigger buffer	Vss	-	0.2Vdd	V	
D032		MCLR, OSC1 (in EC and RC mode)	Vss	-	0.2Vdd	V	Note1
D033		OSC1 (in XT, and LF mode)	-	0.5Vdd	_	V	
		Input High Voltage					
	Vін	I/O ports					
D040		with TTL buffer	2.0	-	Vdd	V	$4.5V \le VDD \le 5.5V$
			1+0.2VDD	-	Vdd	V	$2.5V \le VDD \le 4.5V$
D041		with Schmitt Trigger buffer	0.8Vdd	-	Vdd	V	
D042		MCLR	0.8Vdd	_	Vdd	V	Note1
D043		OSC1 (XT, and LF mode)	-	0.5Vdd	_	V	
D050	VHYS	Hysteresis of	0.15Vdd *	_	-	V	
		Schmitt Trigger inputs					
		Input Leakage Current					
Daga		(Notes 2, 3)					
D060	lı∟	I/O ports (except RA2, RA3)	_	_	±1	μΑ	Vss ≤ VPIN ≤ VDD, I/O Pin at hi-impedance PORTB weak pull-ups disabled
D061		MCLR	-	-	<u>+2</u>	μA	VPIN = Vss or VPIN = VDD
D062		RA2, RA3			±2	μA	$Vss \le Vra2$, $Vra3 \le 12V$
D063		OSC1, TEST (EC, RC modes)	-	-	±1	μA	$Vss \le VPIN \le VDD$
D063B		OSC1, TEST (XT, LF modes)	-	-	VPIN	μA	$R_F \ge 1 M\Omega$, see Figure 14.2
D064		MCLR	-	-	10	μA	VMCLR = VPP = 12V (when not programming)
D070	IPURB	PORTB weak pull-up current	60	200	400	μA	VPIN = VSS, $\overline{\text{RBPU}} = 0$ 4.5V \leq VDD \leq 6.0V

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

t These parameters are for design guidance only and are not tested, nor characterized.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXX devices be driven with external clock in RC mode.

The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 Negative current is defined as coming out of the pin.

3: Negative current is defined as coming out of the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17CXX Programming Specifications (Literature number DS30139).

5: The MCLR/VPP pin may be kept in this range at times other than programming, but is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

Applicable Devices 42 R42 42A 43 R43 44

19.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1. TppS2	opS	3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowerc	ase symbols (pp) and their meanings:		
рр			
ad	Address/Data	ost	Oscillator Start-Up Timer
al	ALE	pwrt	Power-Up Timer
сс	Capture1 and Capture2	rb	PORTB
ck	CLKOUT or clock	rd	RD
dt	Data in	rw	RD or WR
in	INT pin	tO	TOCKI
io	I/O port	t123	TCLK12 and TCLK3
mc	MCLR	wdt	Watchdog Timer
oe	ŌĒ	wr	WR
os	OSC1		
Upperc	ase symbols and their meanings:		
S			
D	Driven	L	Low
E	Edge	P	Period
F	Fall	R	Rise
Н	High	V	Valid
	Invalid (Hi-impedance)	Z	Hi-impedance

Applicable Devices 42 R42 42A 43 R43 44

19.5 <u>Timing Diagrams and Specifications</u>

FIGURE 19-2: EXTERNAL CLOCK TIMING



TABLE 19-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	8	MHz	EC osc mode - 08 devices (8 MHz devices)
		(Note 1)	DC	_	16	MHz	- 16 devices (16 MHz devices)
		(DC	_	25	MHz	- 25 devices (25 MHz devices)
			DC	—	33	MHz	- 33 devices (33 MHz devices)
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	1	_	8	MHz	XT osc mode - 08 devices (8 MHz devices)
			1	_	16	MHz	- 16 devices (16 MHz devices)
			1	_	25	MHz	- 25 devices (25 MHz devices)
			1	_	33	MHz	- 33 devices (33 MHz devices)
			DC	—	2	MHz	LF osc mode
1	Tosc	External CLKIN Period	125	_	—	ns	EC osc mode - 08 devices (8 MHz devices)
		(Note 1)	62.5	_	—	ns	- 16 devices (16 MHz devices)
			40	_	—	ns	- 25 devices (25 MHz devices)
			30.3	—	—	ns	- 33 devices (33 MHz devices)
		Oscillator Period	250	_	—	ns	RC osc mode
		(Note 1)	125	_	1,000	ns	XT osc mode - 08 devices (8 MHz devices)
			62.5	_	1,000	ns	- 16 devices (16 MHz devices)
			40	—	1,000	ns	- 25 devices (25 MHz devices)
			30.3	—	1,000	ns	- 33 devices (33 MHz devices)
			500	—	—	ns	LF osc mode
2	Тсү	Instruction Cycle Time (Note 1)	121.2	4/Fosc	DC	ns	
3	TosL,	Clock in (OSC1)	10 ±	_	_	ns	EC oscillator
	TosH	high or low time	· '				
4	TosR,	Clock in (OSC1)	_	_	5‡	ns	EC oscillator
	TosF	rise or fall time					

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

t These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.

Applicable Devices 42 R42 42A 43 R43 44

FIGURE 20-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



FIGURE 20-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



APPENDIX E: PIC16/17 MICROCONTROLLERS

E.1 PIC14000 Devices



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				Clock	Memory	ory		Peripł	Peripherals	\vdash	Features
		CHANN CON		FLOULOUX (FLOULOUX)		\backslash		\backslash	6		
			10 00 to 10	And the solo			\backslash	10783			-7016).
		Uenberg		A HOU	S ano		je e		200	SUR	Aces -
	Tely .	deli HIMIII	10,	ow isuit to we the	ROUTOS WALL	RULAILI DO	ALL RELIGION		Suits		Service 101 101 101 101 101
PIC16C554	20	512	80	TMR0			ю	13	2.5-6.0		18-pin DIP, SOIC; 20-pin SSOP
PIC16C556	20	¥	80	TMR0			ю	13	2.5-6.0	1	18-pin DIP, SOIC; 20-pin SSOP
PIC16C558	20	2K	128	TMR0	I	I	e	13	2.5-6.0	Ι	18-pin DIP, SOIC; 20-pin SSOP
PIC16C620	20	512	80	TMR0	2	Yes	4	13	2.5-6.0	Yes	18-pin DIP, SOIC; 20-pin SSOP
PIC16C621	20	ź	80	TMR0	2	Yes	4	13	2.5-6.0	Yes	18-pin DIP, SOIC; 20-pin SSOP
PIC16C622	20	2K	128	TMR0	2	Yes	4	13	2.5-6.0	Yes	18-pin DIP, SOIC; 20-pin SSOP
All PIC16/17 Fan	/17 Far	nily devic	es have	Power-on	Reset,	selecta	able W	atchdo	g Timer, s	electal	All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O

current capability. All PIC16C6XXX Family devices use serial programming with clock pin RB6 and data pin RB7.

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E.4 PIC16C6X Family of Devices

					L	Memory	лс			Peripherals	erals			Features
			Tote and	Sike BE	RECTORNAL TO COMPANY TO THE STORE ST		Contraction of the second seco	ONIE DINA	THE STATES	Tay to	2		SHOT N	Solution of the solution of th
		VI LE MULL		10	HOOM POLIS	no X	September (0)	SHOP IN	and the second	S. Chilles	est cool and the citolic set	in the second		Solotoe & LINOULAND
PIC16C62	20	2K	Ι	128	TMR0, TMR1, TMR2	-	SPI/I ² C	Ι	7	22	3.0-6.0	Yes	Ι	28-pin SDIP, SOIC, SSOP
PIC16C62A ⁽¹⁾	20	2K	1	128	TMR0, TMR1, TMR2	-	SPI/I ² C	I	2	22	2.5-6.0	Yes	Yes	28-pin SDIP, SOIC, SSOP
PIC16CR62 ⁽¹⁾	20	Ι	2K	128	TMR0, TMR1, TMR2	-	SPI/I ² C	Ι	2	22	2.5-6.0	Yes	Yes	28-pin SDIP, SOIC, SSOP
PIC16C63	20	4K	Ι	192	TMR0, TMR1, TMR2	2	SPI/I ² C, USART	I	10	22	2.5-6.0	Yes	Yes	28-pin SDIP, SOIC
PIC16CR63 ⁽¹⁾	20	I	,	192	TMR0, TMR1, TMR2	2	SPI/I ² C, USART	I	10	22	2.5-6.0	Yes	Yes	28-pin SDIP, SOIC
PIC16C64	20	2K	Ι	128	TMR0, TMR1, TMR2	~	SPI/I ² C	Yes	ø	33	3.0-6.0	Yes	I	40-pin DIP; 44-pin PLCC, MQFP
PIC16C64A ⁽¹⁾	20	2K		128	TMR0, TMR1, TMR2	٢	SPI/I ² C	Yes	8	33	2.5-6.0	Yes	Yes	40-pin DIP; 44-pin PLCC, MQFP, TQFP
PIC16CR64 ⁽¹⁾	20	Ι	2K	128	TMR0, TMR1, TMR2	~	SPI/I ² C	Yes	œ	33	2.5-6.0	Yes	Yes	40-pin DIP; 44-pin PLCC, MQFP, TQFP
PIC16C65	20	4K	Ι	192	TMR0, TMR1, TMR2	2	SPI/I ² C, USART	Yes	11	33	3.0-6.0	Yes	I	40-pin DIP; 44-pin PLCC, MQFP
PIC16C65A ⁽¹⁾	20	4K		192	TMR0, TMR1, TMR2	2	SPI/I ² C, USART	Yes	11	33	2.5-6.0	Yes	Yes	40-pin DIP; 44-pin PLCC, MQFP, TQFP
PIC16CR65 ⁽¹⁾	20		4K	192	TMR0, TMR1, TMR2	2	SPI/I ² C, USART	Yes	11	33	2.5-6.0	Yes	Yes	40-pin DIP; 44-pin PLCC, MQFP, TQFP
All PI All PI	C16/17 C16C6	r family X fami	y devic ily devi	tes hav ices us	All PIC16/17 family devices have Power-on Reset, selectable Watchdog Timer, selectable o All PIC16C6X family devices use serial programming with clock pin RB6 and data pin RB7	set, s nmin	electable g with clo	Watch ck pin	dog Ti RB6 a	mer, s nd dat	electable d a pin RB7	ode pi	rotect,	All PIC16/17 family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect, and high I/O current capability. All PIC16C6X family devices use serial programming with clock pin RB6 and data pin RB7.

All PIC16C6X family devices use serial programming with clock pin RB6 and data pin Note 1: Please contact your local sales office for availability of these devices.

E.6 **PIC16C8X Family of Devices**



÷ Note

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